

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Yu-Hui Chou</td><td>08/27/2008</td></tr><tr><td>Pei-Chun Liao</td><td>08/27/2008</td></tr><tr><td>Hsueh-Ying Huang</td><td>08/27/2008</td></tr></tbody></table>	Name	Execution Date	Yu-Hui Chou	08/27/2008	Pei-Chun Liao	08/27/2008	Hsueh-Ying Huang	08/27/2008	
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Yu-Hui Chou	08/27/2008								
Pei-Chun Liao	08/27/2008								
Hsueh-Ying Huang	08/27/2008								
RECEIVING PARTY DATA									
Name:	Au Optronics Corporation								
Street Address:	No. 1, Li-Hsin Rd. II, Science-Based Industrial Park								
City:	Hsinchu								
State/Country:	TAIWAN								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>12233611</td></tr></tbody></table>	Property Type	Number	Application Number:	12233611					
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Application Number:	12233611								
CORRESPONDENCE DATA									
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ATTORNEY DOCKET NUMBER:	26973-US-PA								
NAME OF SUBMITTER:	Belinda Lee								
Total Attachments: 2 source=26973ASSIGNMENT#page1.tif source=26973ASSIGNMENT#page2.tif									

CH \$40.00 12233611

ASSIGNMENT

WHEREAS,

1. Chou, Yu-Hui
2. Liao, Pei-Chun
3. Huang, Hsueh-Ying

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **THIN FILM TRANSISTOR ARRAY SUBSTRATE**

☐ Filed: Serial No.

☒ Executed concurrently with the execution of this instrument

WHEREAS, Au Optonics Corporation
of No. 1, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Chou Yu-Hui
Sole or First Joint Inventor: Chou, Yu-Hui

Date: Aug. 27, 2008

Signature: Liao, Pei-Chun
Second Joint Inventor (if any): Liao, Pei-Chun

Date: Aug. 27, 2008

Signature: Huang, Hsueh-Ying
Third Joint Inventor (if any): Huang, Hsueh-Ying

Date: Aug. 27, 2008